

NCE N-Channel Enhancement Mode Power MOSFET

Description

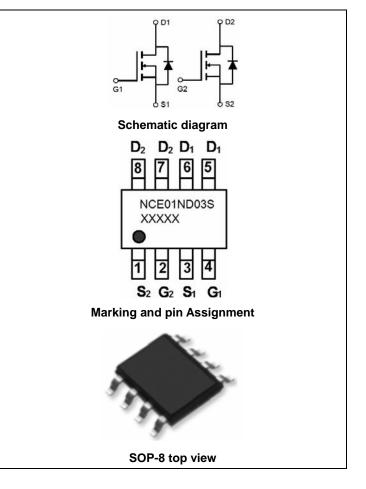
The NCE01ND03S uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

- V_{DS} =100V,I_D =3A
 R_{DS(ON)} < 130mΩ @ V_{GS}=10V
 R_{DS(ON)} < 140mΩ @ V_{GS}=4.5V
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE01ND03S	NCE01ND03S	SOP-8	Ø330mm	12mm	4000 units

Absolute Maximum Ratings (T_A=25℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	100	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	Ι _D	3	А
Drain Current-Continuous(T _C =100℃)	I _D (100℃)	2.1	А
Pulsed Drain Current ^(Note 1)	I _{DM}	12	А
Maximum Power Dissipation	PD	2	W
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 150	°C

Thermal Characteristic

Parameter	Symbol	Тур	Max	Unit
Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{ extsf{ heta}JA}$	62.5	85	°C/W



Electrical Characteristics (T_A=25[°]C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit	
Off Characteristics				•			
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	100	110	-	V	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =100V,V _{GS} =0V	-	-	1	μA	
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA	
On Characteristics (Note 3)							
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250µA	1.0	1.5	2.0	V	
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =3A	-	95	130	m0	
Drain-Source On-State Resistance		V _{GS} =4.5V, I _D =3A		100	140	mΩ	
Forward Transconductance	g fs	V _{DS} =5V,I _D =3A	3.5	-	-	S	
Dynamic Characteristics (Note4)							
Input Capacitance	Clss	V _{DS} =50V,V _{GS} =0V,	-	730	-	PF	
Output Capacitance	Coss	F=1.0MHz	-	37	-	PF	
Reverse Transfer Capacitance	C _{rss}		-	27	-	PF	
Switching Characteristics (Note 4)							
Turn-on Delay Time	t _{d(on)}		-	11	-	nS	
Turn-on Rise Time	tr	V_{DD} =50V, R _L =15 Ω	-	7.4	-	nS	
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10V, R_{G} =2.5 Ω	-	35	-	nS	
Turn-Off Fall Time	t _f		-	9.1	-	nS	
Total Gate Charge	Qg		-	21.5		nC	
Gate-Source Charge	Q _{gs}	V _{DS} =50V,I _D =3A, V _{GS} =10V	-	3.2	-	nC	
Gate-Drain Charge	Q_gd	V _{GS} -10V	-	6	-	nC	
Drain-Source Diode Characteristics				•			
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =3A	-	-	1.2	V	
Diode Forward Current (Note 2)	Is		-	-	3	А	
Reverse Recovery Time	t _{rr}	TJ = 25°C, I _F =3A	-	26		nS	
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	27		nC	
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD				y LS+LD)	

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

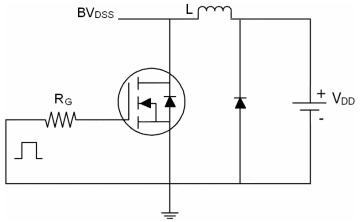
2. The value of R_{BJA} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A=25°C. The value in any given application depends on the user's specific board design.Surface Mounted on FR4 Board, t \leq 10 sec. The current rating is based on the t \leq 10s thermal resistance rating.

3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.

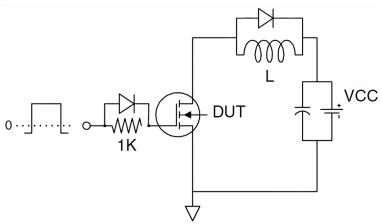
4. Guaranteed by design, not subject to production .



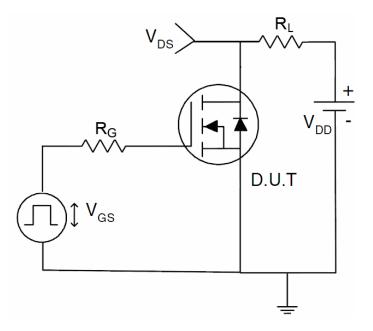
Test Circuit 1) E_{AS} Test Circuits



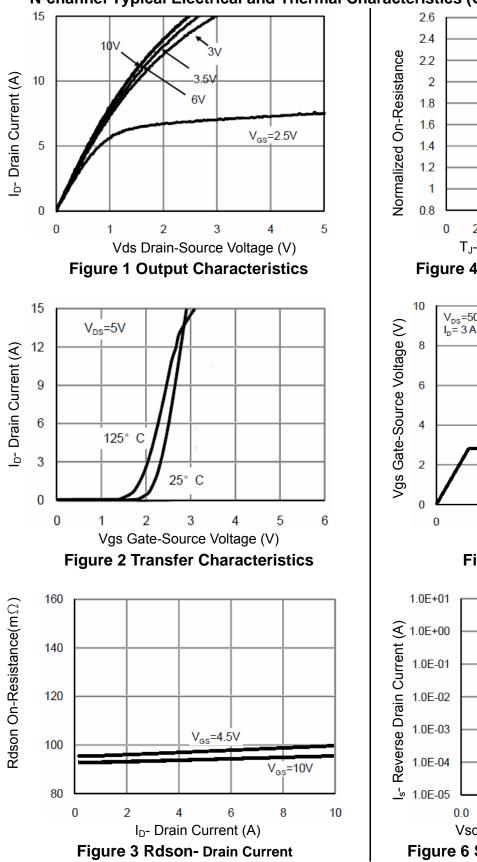
2) Gate Charge Test Circuit:



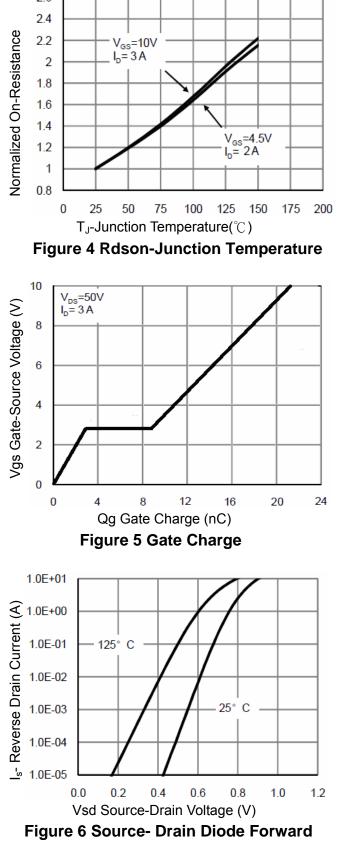
3) Switch Time Test Circuit:







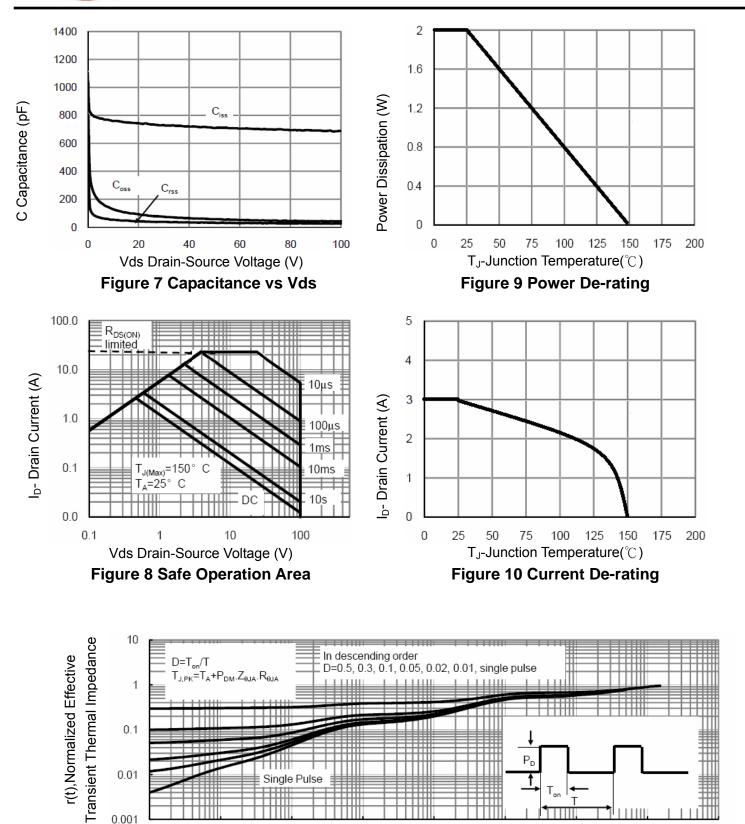






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NCE01ND03S



Square Wave Pluse Duration(sec) Figure 11 Normalized Maximum Transient Thermal Impedance

0.1

1

10

100

1E-05

0.0001

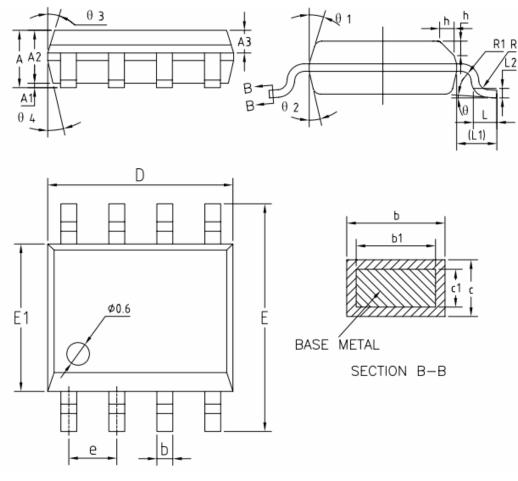
0.001

0.01

1000



SOP-8 Package Information



COMMON DIMENSIONS (UNITS OF MEASURE=MILLIMETER)

SYMBOL	MIN	NOM	MAX	
Α	1.35	1.55	1.75	
A1	0.10	0.15	0.25	
A2	1.25	1.40	1.65	
A3	0.50	0.60	0.70	
b	0.38	-	0.51	
b1	0.37	0.42	0.47	
с	0.18	-	0.25	
c1	0.17	0.20	0.23	
D	4.80	4.90	5.00	
E	5.80	6.00	6.20	
E1	3.80	3.90	4.00	
e	1.17	1.27	1.37	
L	0.45	0.60	0.80	
L1	1.04REF			
L2	0.25BSC			
R	0.07	_	-	
R1	0.07	-	-	
h	0.30	0.40	0.50	
θ	0.	-	8'	
θ1	15 '	17 °	19*	
θ2	11	13 °	15°	
θ3	15 '	17	19*	
θ4	11'	13°	15 °	



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